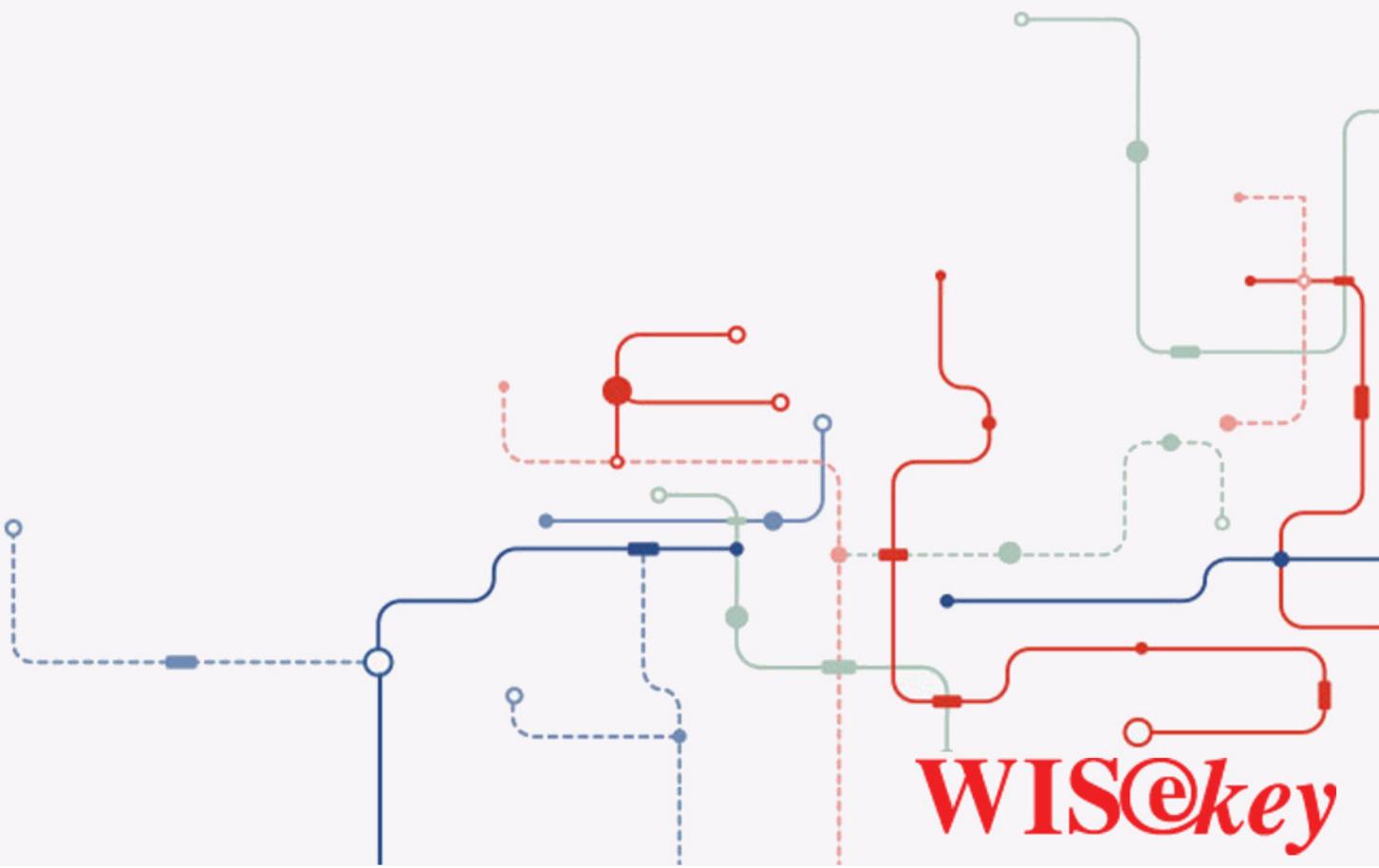


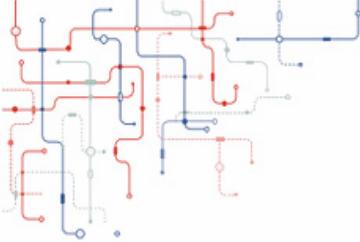


**MS6001**

## Summary Datasheet



**WISEkey**



# Features

## General

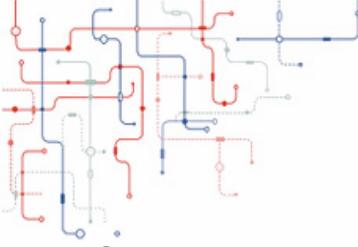
- Based on the ARM® SecurCore® SC300™ 32-bit RISC Processor featuring:
  - Harvard architecture
  - Thumb2® High-code-density Instruction Set
  - 3-stage pipeline architecture
  - 8-bit,16-bit,32-bit data access
  - Nested Vector Interrupt Controller
  - Memory Protection Unit
- On-chip Programmable System Clock up to 50MHz
- Very Low Power Consumption
  - GSM & ETSI compliant
  - Low power Idle and Power down Modes
- Bond Pad Locations Conforming to ISO7816-2
- ESD Protection :  $\pm 4000V$
- Operating range:
  - From 1.62V to 5.5V
  - From - 40°C to 105°C
- Compliant with GSM, 3GPP, EMVCo Specifications

## Memory

- 1MBytes of FLASH Memory:
  - Pages of 128 bytes
  - 2 Kbytes of OTP
- 500,000 Write/Erase Cycles at 25°C using Wear-Leveling
- 10 Years Data Retention
- Flash write & erase low power modes
- 64 Kbytes of ROM for Crypto Library, Wear-Leveling and Secure Bootloader code
- 24 Kbytes of RAM Memory (20 Kbytes of ARM CPU Core RAM, 4 Kbytes of Ad-X™3 RAM, shared with the ARM CPU Core)

## Peripherals

- One ISO 7816 Controller
  - Up to 625 Kbps at 5MHz
  - Compliant with T=0 and T=1 Protocols
- SWP Slave interface: Single Wire Protocol controller for communications with NFC chip
- High Speed SPI Interface up to 20Mbits/s
- I²C Interface up to 1Mbits/s
- 5 GPIOs (including IO0 and IO1)
- Three 16-bit Timers
- SysTick 24-bit timer, part of the SC300
- Interfaces and Class detectors
- Random Number Generator (RNG)
- Hardware DES/TDES DPA /DEMA Resistant
- Hardware AES
- CRC 16 & 32 Engine (Compliant with ISO/IEC 3309)
- 32-bit Cryptographic Accelerator (Ad-X3 for Public Key Operations)
  - RSA, DSA, ECC, ECDH
- High performance Hardware Java Card Accelerator



## Security

- Dedicated Hardware for Protection Against SPA/DPA/SEMA/DEMA Attacks
- Advanced Protection Against Physical Attack, Including Active Shield, Enhanced Protection Object, Stack Checker, Slope Detector, Parity Errors
- Environmental Protection Systems
- Voltage Monitor
- Frequency Monitor
- Temperature Monitor
- Light Protection
- Secure Memory Management/Access Protection
- Memory Protection Unit, part of the SC300

## Development Tools

- IAR Embedded Workbench® EWARM <sup>(1)</sup>
- Software Libraries and Application Notes

## Certification Targeted

- EMVCo
- AIS-31
- CC EAL5+
- FIPS 140-3

1. Licence not included - contact IAR

## Description

The MS6001 architecture is based on the ARM® SecurCore® SC300 which offer high performance and very low power consumption. The core features a Thumb-2 instruction set, low interrupt latency, hardware divide, interruptible/continuable multiple load and store instructions, automatic state save and restore for interrupts, tightly integrated interrupt controller and multiple core buses capable of simultaneous accesses. Pipeline techniques are employed ensuring that all parts of the processing and memory systems can operate continuously.

The SC300 instruction set provides the exceptional performance expected of a modern 32-bit architecture, with the high code density of 8-bit and 16-bit microcontrollers. The processor closely integrates a configurable nested vectored interrupt controller (NVIC), to deliver industry leading interrupt performance. To offer efficient low-power modes, the NVIC features a deep sleep function that enables the entire device to be rapidly powered down.

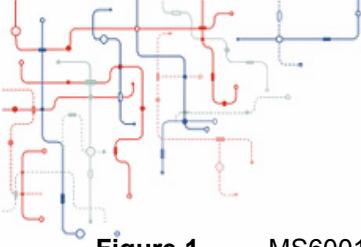
The MS6001 features a ROM memory dedicated to the storage of low level drivers, bootloader, Wear Leveling and cryptographic code. A large flash memory mapped in both data and code space provide a flexible way to store user data and program code.

The Ad-X3 hardware cryptographic accelerator featured in the MS6001 is dedicated to perform fast encryption or authentication functions.

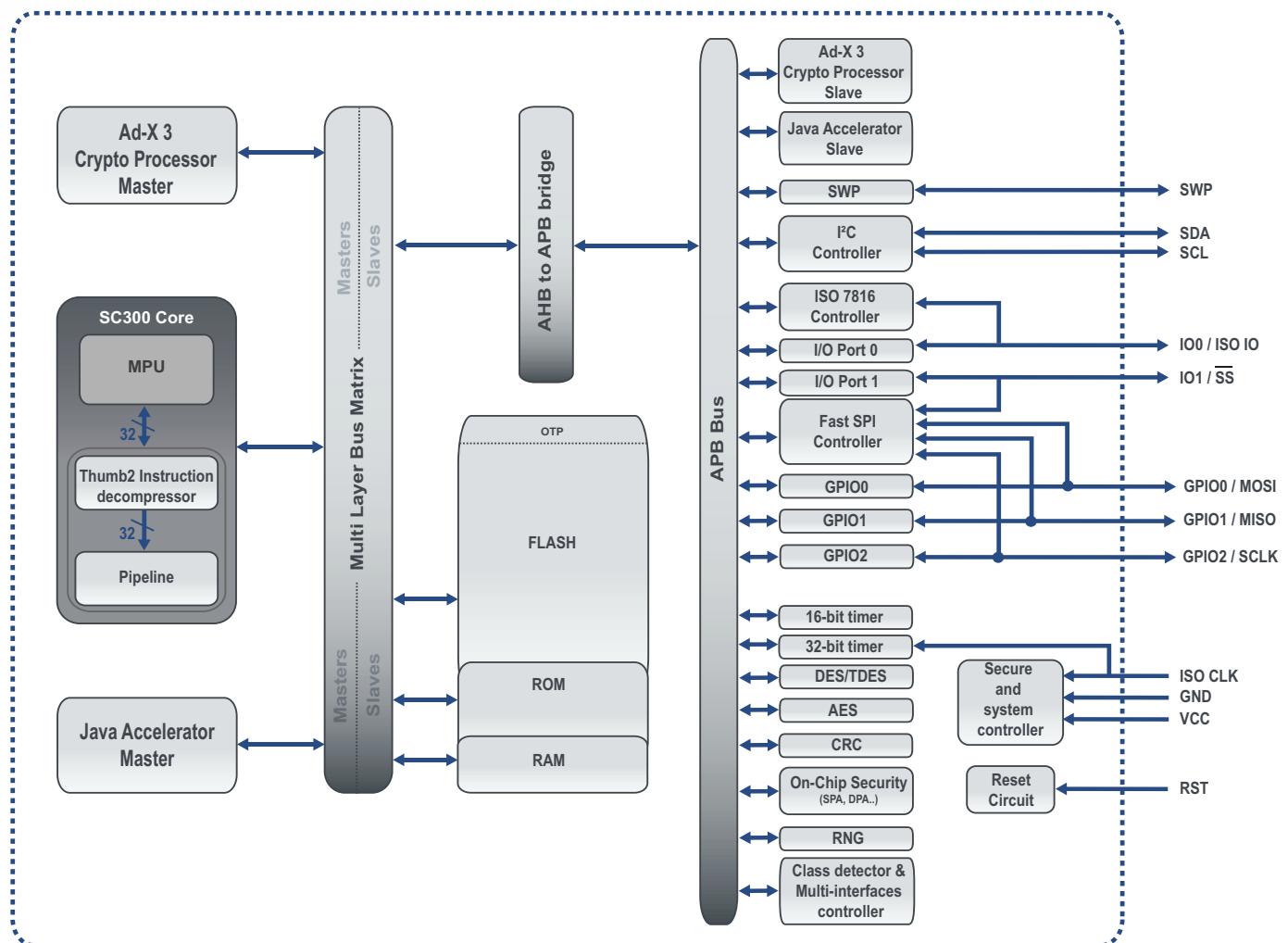
Thanks to the built-in MPU of the SC300, the MS6001 can enforce privilege rules, separate processes, enforce access rules over the entire 4GB addressing space.

Additional security features include fault injection resistance, hardware shield, scrambling of program, data and addresses, power analysis countermeasures and memory accesses controller by privileged modes.

Thanks to its dedicated set of peripherals, the MS6001 is an ideal product for application such as a Secure Element, compliant to ETSI standards. Moreover, through its specific choice of communication interfaces, the MS6001 is able to provide a tailored solution to applications in embedded systems.



**Figure 1** MS6001 ARM CPU Core Architecture





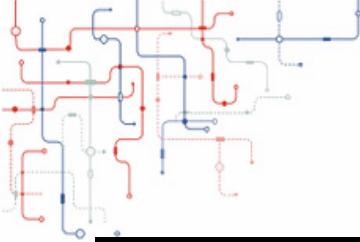
# AC/DC Characteristics

## Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit
Supply Voltage	V <sub>CC</sub>	-0.3	7	V
Operating Temperature	T <sub>A</sub>	-40	+105	°C

## AC/DC Characteristics (1.62V - 5.50V range; T= -40°C to +105°C)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
V <sub>CC</sub>	Supply Voltage		1.62		5.5	V
F <sub>VFO</sub>	Processor Clock Input Frequency	with Vcc=4.5V config 20MHz config 50MHz	18 46	20 50	24 61	MHz
F <sub>peripheral</sub>	Peripheral Clock Frequency	with Vcc=4.5V	18	22	24	MHz
V <sub>MAX</sub>	Voltage Monitor: High Level Detection		6.1	6.3	6.4	V
V <sub>MIN</sub>	Voltage Monitor: Low Level Detection		1.1	1.2	1.6	V
T <sub>MAX</sub>	Temperature monitor High Level Detection			110		°C
T <sub>MIN</sub>	Temperature monitor Low Level Detection			-40		°C
V <sub>POR</sub>	Power-on Reset Voltage		1	1	1.45	V
t <sub>POR</sub>	Power-on Reset Period	V <sub>CC</sub> =5V V <sub>CC</sub> rise time=10μs LowPowerStartup=0 LowPowerStartup=1		112 226		μs
t <sub>TOUT</sub>	Reset Delay Time-out Period	warm reset ISO400 fuse = 0		523		t <sub>CYC</sub>
		warm reset ISO400 fuse = 1		the longest of 523 t <sub>CYC</sub> or 7 t <sub>CYC</sub> + 403 t <sub>isoclk</sub>		
		POR (cold reset) LowPowerStartup=0 LowPowerStartup=1		980 2549		t <sub>CYC</sub>
t <sub>FLASHW</sub>	FLASH Write Time	per word	50	55	60	μs
t <sub>FLASHE</sub>	FLASH Erase Time	per 2Kbytes sector	2	2+0.5	10	ms
t <sub>CYC</sub>	CPU Cycle Time	LowPowerStartup=0 LowPowerStartup=1		4.10 <sup>9</sup> /F <sub>VFO</sub> 10 <sup>9</sup> /F <sub>VFO</sub>		ns
RST I <sub>IL</sub>	Leakage Current RST	V <sub>IN</sub> =0V		0		μA
RST I <sub>IH</sub>	Leakage Current RST	V <sub>IN</sub> =Vcc		0		μA
RST V <sub>IH</sub>	Input High Voltage, RST signal		0.7xVcc	NA	Vcc+0.3	V
RST V <sub>IL</sub>	Input Low Voltage, RST signal		-0.3	NA	0.2 x Vcc	V
CLK I <sub>IL</sub>	Leakage Current CLK	V <sub>IN</sub> = 0		0		μA
CLK I <sub>IH</sub>	Leakage Current CLK	V <sub>IN</sub> = Vcc		0		μA
CLK V <sub>IH</sub>	Input High Voltage, CLK signal		0.7xVcc	NA	Vcc+0.3	V



Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
CLK $V_{IL}$	Input Low Voltage, CLK signal		-0.3	NA	$0.2 \times Vcc$	V
I/O $I_{IL}$	Leakage Current I/O	$V_{IN}=0$		0		$\mu A$
I/O $I_{IH}$	Leakage Current I/O	$V_{IN}=Vcc$		0		$\mu A$
I/O $V_{IH}$	Input High Voltage, I/O signal		$0.7 \times Vcc$	NA	$Vcc+0.3$	V
I/O $V_{IL}$	Input Low Voltage, I/O signal		-0.3	NA	$0.2 \times Vcc$	V
I/O $V_{OH}$	Output High Voltage, I/O signal	$I_{OH}=20\mu A$ $R_{PULLUP}=20K$	$0.7 \times Vcc$			V
I/O $V_{OL}$	Output Low Voltage, I/O signal	$I_{OL}<1mA$ , ClassA			$0.08 \times Vcc$	V
I/O $V_{OL}$	Output Low Voltage, I/O signal	$I_{OL}<0.5mA$ , ClassB			$0.15 \times Vcc$	V
I/O $V_{OL}$	Output Low Voltage, I/O signal	$I_{OL}<0.5mA$ , ClassC			$0.15 \times Vcc$	V
Tr	I/O Output Rise Time	$C_{out} = 30 pF$ , $R_{PULLUP} = 220K$	9.2	12.1	18.3	ns
Tf	I/O Output Fall Time	$C_{out} = 30 pF$	10.1	13.0	20.1	ns
$R_{I/O\ PULLUP}$	RST Pin Pullup IO0, IO1, GPIO0 to 2 Pin Pullup SCK Pin Pullup SWP Pin Pullup			220 220 220 900		$k\Omega$
$R_{I/O\ PULLDOWN}$	RST Pin Pulldown IO0, IO1, GPIO0 to 2 Pin Pulldown SCK Pin Pulldown SWP pad Pulldown			1000 1000 1000 900		$k\Omega$

Note: 1. In deep sleep Mode, the external clock can be stopped. The Frequency and temperature Monitors are switched off



## Typical power consumption.

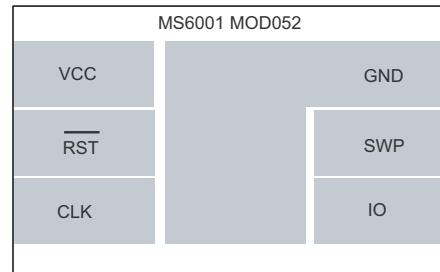
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
$I_{PDN-T}$	IDD total in Power down mode	config 20MHz 4.5V < VCC < 5.50V 2.7V < VCC < 4.5V 1.62V < VCC < 2.7V  config 50MHz 4.5V < VCC < 5.50V 2.7V < VCC < 4.5V 1.62V < VCC < 2.7V		97 86 80  121 105 98		$\mu A$
$I_{RUN}$	IDD when CPU runs	config 20MHz 4.5V < VCC < 5.50V 2.7V < VCC < 4.5V 1.62V < VCC < 2.7V  config 50MHz 4.5V < VCC < 5.50V 2.7V < VCC < 4.5V 1.62V < VCC < 2.7V		5.1 4.6 4.4  8.6 7.9 7.6		$mA$
$I_{Ad-X3}$	IDD when Ad-X3 runs	config 20MHz 4.5V < VCC < 5.50V 2.7V < VCC < 4.5V 1.62V < VCC < 2.7V  config 50MHz 4.5V < VCC < 5.50V 2.7V < VCC < 4.5V 1.62V < VCC < 2.7V		6.3 5.9 5.7  12 11.3 11.0		$mA$
$I_{Worst}$	IDD when all features run	config 20MHz 4.5V < VCC < 5.50V 2.7V < VCC < 4.5V 1.62V < VCC < 2.7V  config 50MHz 4.5V < VCC < 5.50V 2.7V < VCC < 4.5V 1.62V < VCC < 2.7V		8.8 8.3 8.1  17.9 17.2 16.8		$mA$



# Pin and Packages Configurations

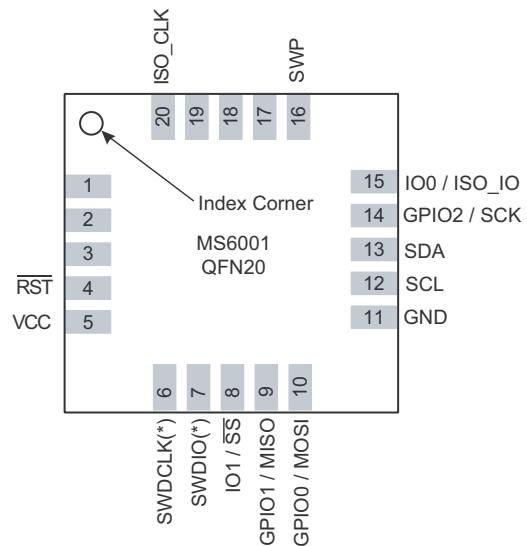
## Module

<b>GND</b>	Ground (reference voltage)
<b>VCC</b>	Power supply input
<b>ISO IO</b>	Input or Output for serial data (ISO 7816)
<b>ISO CLK</b>	ISO CLK ISO 7816 input clock
<b>ISO RST</b>	ISO Reset signal input
<b>SWP</b>	SWP dedicated pin



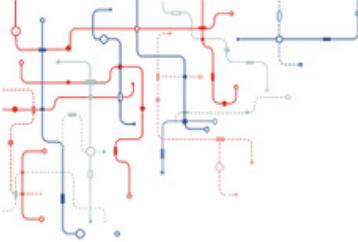
## QFN20

<b>GND</b>	Ground (reference voltage)
<b>VCC</b>	Power supply input
<b>IO1 / SS</b>	IO1 or SPI Slave Select
<b>GPIO0 / MOSI</b>	GPIO0 or SPI MOSI
<b>GPIO1 / MISO</b>	GPIO1 or SPI MISO
<b>GPIO2 / SCK</b>	GPIO2 or SPI clock
<b>SDA</b>	I2C SDA
<b>SCL</b>	I2C SCL
<b>SWP</b>	Single Wire Protocol
<b>IO0 / ISO_IO</b>	IO0 or ISO IO
<b>ISO_CLK</b>	ISO CLK ISO 7816 input clock
<b>RST</b>	Reset
<b>SWDCLK(*)</b>	Single Wire Debug Clock
<b>SWDIO(*)</b>	Single Wire Debug IO

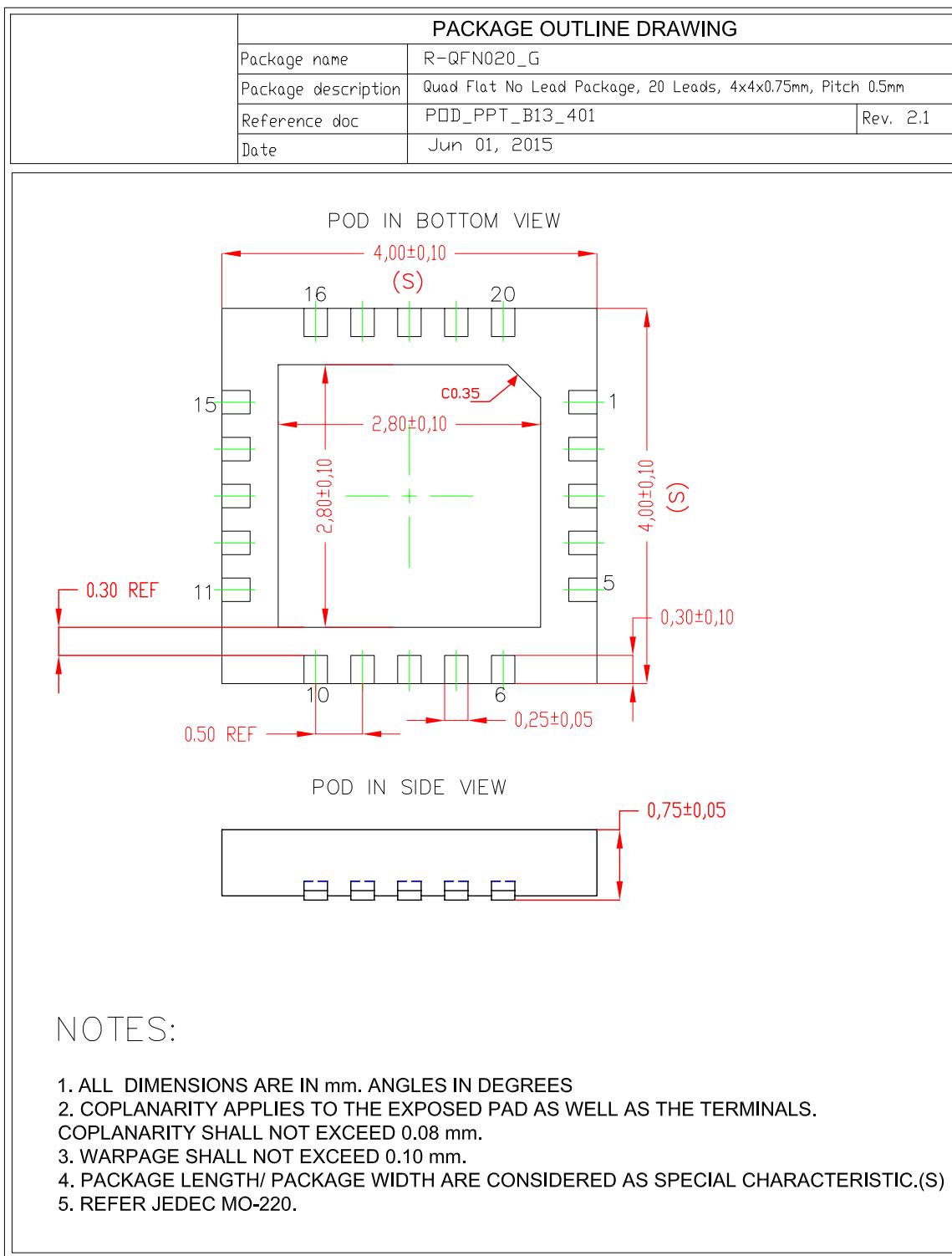


(\*) only for engineering sample

Configuration	Interfaces Available	Package
QFN20	ISO (or 1 GPIO) + SWP + I2C + SPI (or 4 GPIO)	QFN20 (4*4)



# Package outline



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